

ITO-220



TO-220



Pin Definition:

1. Gate
2. Drain
3. Source

PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
600	1.2 @ $V_{GS} = 10V$	3.5

General Description

The TSM7N60 N-Channel enhancement mode Power MOSFET is produced by planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply, power factor correction, electronic lamp ballast based on half bridge.

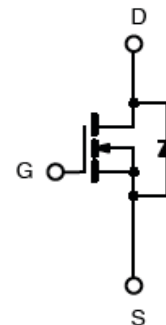
Features

- Low $R_{DS(on)}$ 1.2 Ω (Max.)
- Low gate charge typical @ 28nC (Typ.)
- Low C_{rss} typical @ 12pF (Typ.)
- Fast Switching

Ordering Information

Part No.	Package	Packing
TSM7N60CZ C0	TO-220	50pcs / Tube
TSM7N60CI C0	ITO-220	50pcs / Tube

Block Diagram



N-Channel MOSFET

Absolute Maximum Rating ($T_a = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current	I_D	$T_a = 25^\circ C$	7
		$T_a = 100^\circ C$	3.2
Pulsed Drain Current *	I_{DM}	28	A
Avalanche Current (Single) (Note 2)	I_{AS}	7	A
Single Pulse Avalanche Energy (Note 2)	E_{AS}	230	mJ
Avalanche Current (Repetitive) (Note 1)	I_{AR}	7	A
Repetitive Avalanche Energy (Note 1)	E_{AR}	7.5	mJ
Maximum Power Dissipation @ $T_a = 25^\circ C$	P_D	65	W
Operating Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ C$

* Limited by maximum junction temperature

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Case	$R\theta_{JC}$	1.92	$^{\circ}\text{C/W}$
Thermal Resistance - Junction to Ambient	$R\theta_{JA}$	83.3	$^{\circ}\text{C/W}$

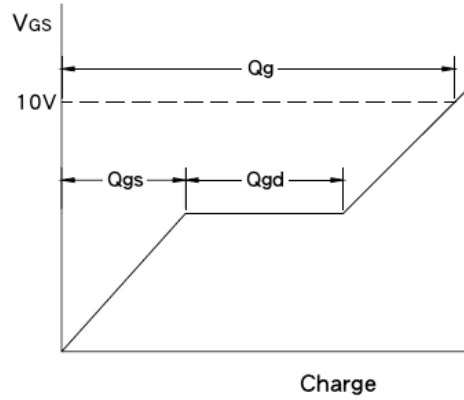
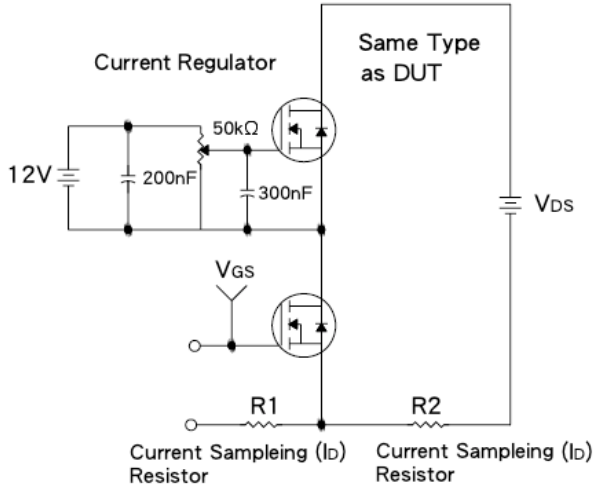
 Notes: Surface mounted on FR4 board $t \leq 10\text{sec}$
Electrical Specifications ($T_a = 25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	BV_{DSS}	600	--	--	V
Drain-Source On-State Resistance	$V_{GS} = 10\text{V}, I_D = 3.5\text{A}$	$R_{DS(ON)}$	--	1.0	1.2	Ω
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	$V_{GS(TH)}$	2.0	--	4.0	V
Zero Gate Voltage Drain Current	$V_{DS} = 600\text{V}, V_{GS} = 0\text{V}$	I_{DSS}	--	--	1	μA
Gate Body Leakage	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$	I_{GSS}	--	--	± 100	nA
Forward Transfer Conductance	$V_{DS} = 10\text{V}, I_D = 3.5\text{A}$	g_{fs}	--	7.3	--	S
Diode Forward Voltage	$I_S = 7\text{A}, V_{GS} = 0\text{V}$	V_{SD}	--	--	1.4	V
Dynamic^b						
Total Gate Charge	$V_{DS} = 300\text{V}, I_D = 7\text{A}, V_{GS} = 10\text{V}$	Q_g	--	28	42	nC
Gate-Source Charge		Q_{gs}	--	5.5	8.3	
Gate-Drain Charge		Q_{gd}	--	11	17	
Input Capacitance	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$	C_{iss}	--	950	1430	pF
Output Capacitance		C_{oss}	--	85	130	
Reverse Transfer Capacitance		C_{rss}	--	12	18	
Switching^c						
Turn-On Delay Time	$V_{GS} = 10\text{V}, I_D = 7\text{A}, V_{DD} = 300\text{V}, R_G = 25\Omega$	$t_{d(on)}$	--	16	--	nS
Turn-On Rise Time		t_r	--	60	--	
Turn-Off Delay Time		$t_{d(off)}$	--	80	--	
Turn-Off Fall Time		t_f	--	65	--	
Reverse Recovery Time	$V_{GS} = 0\text{V}, I_S = 7\text{A}$	t_{rr}	--	365	--	nS
Reverse Recovery Charge	$di_f/dt = 100\text{A/us}$	Q_{rr}	--	4.23	--	μC

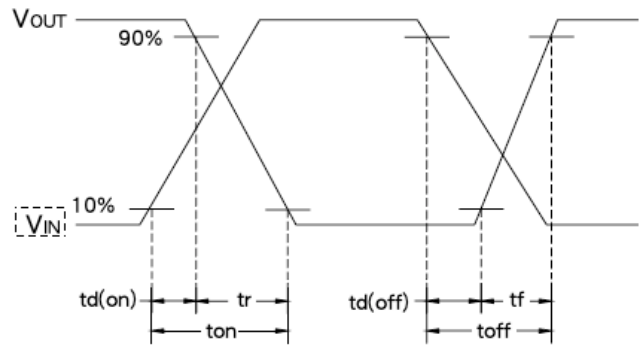
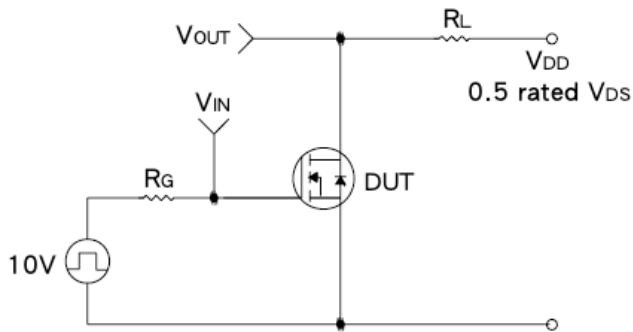
Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. $V_{DD} = 50\text{V}, I_{AS} = 7\text{A}, L = 9.8\text{mH}, R_G = 27\Omega$
3. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
4. Essentially Independent of Operating Temperature

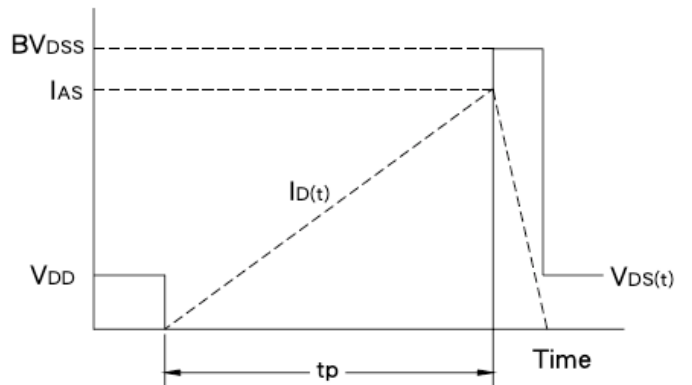
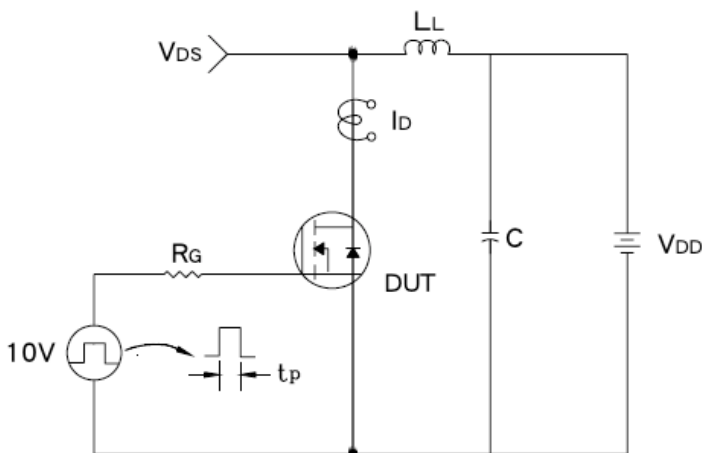
Gate Charge Test Circuit & Waveform



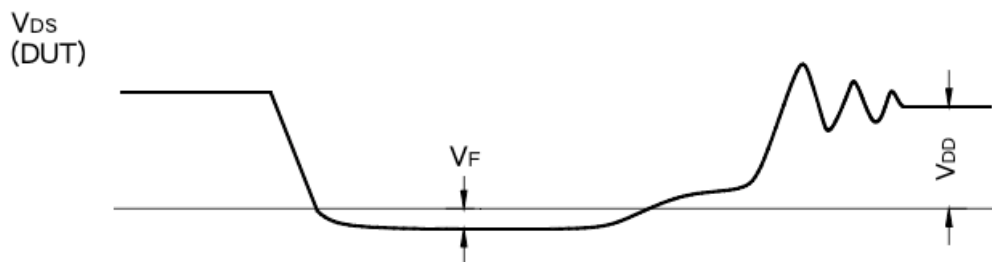
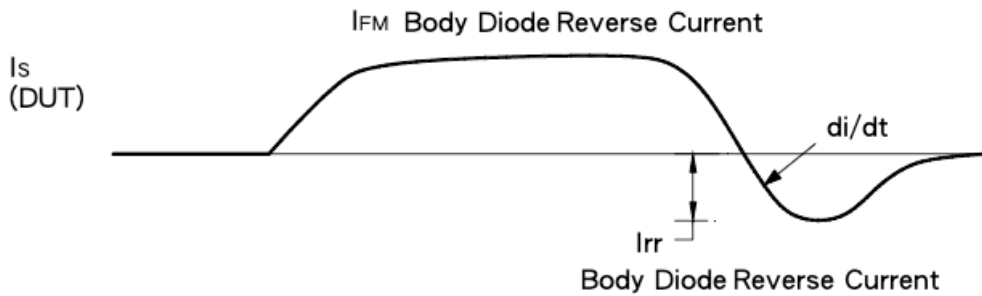
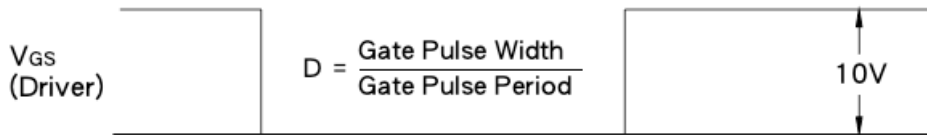
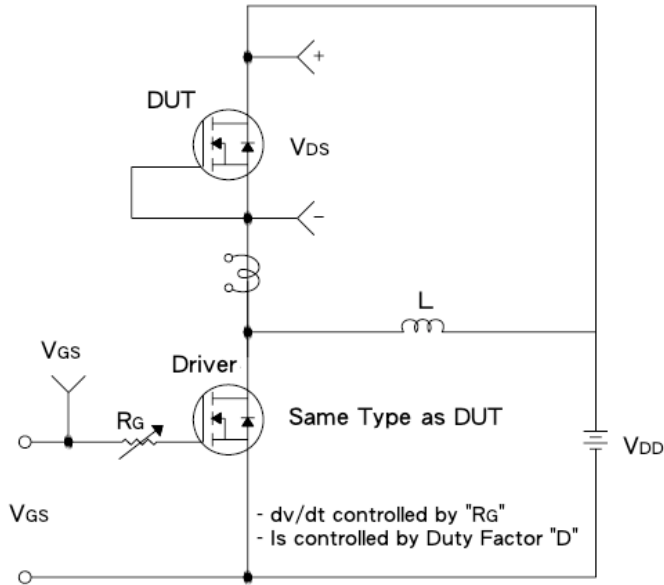
Resistive Switching Test Circuit & Waveform



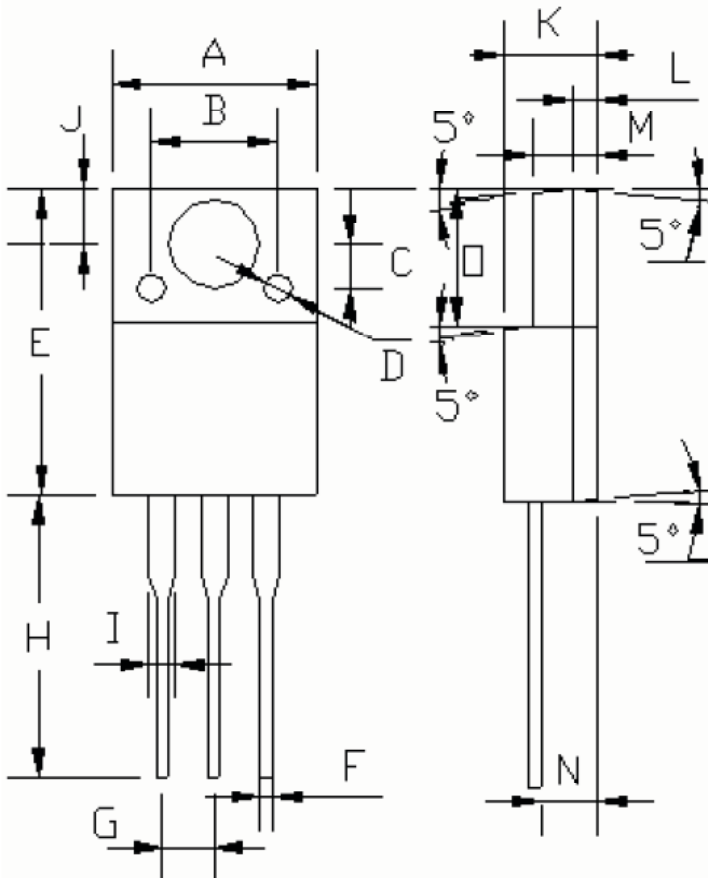
EAS Test Circuit & Waveform



Diode Reverse Recovery Time Test Circuit & Waveform

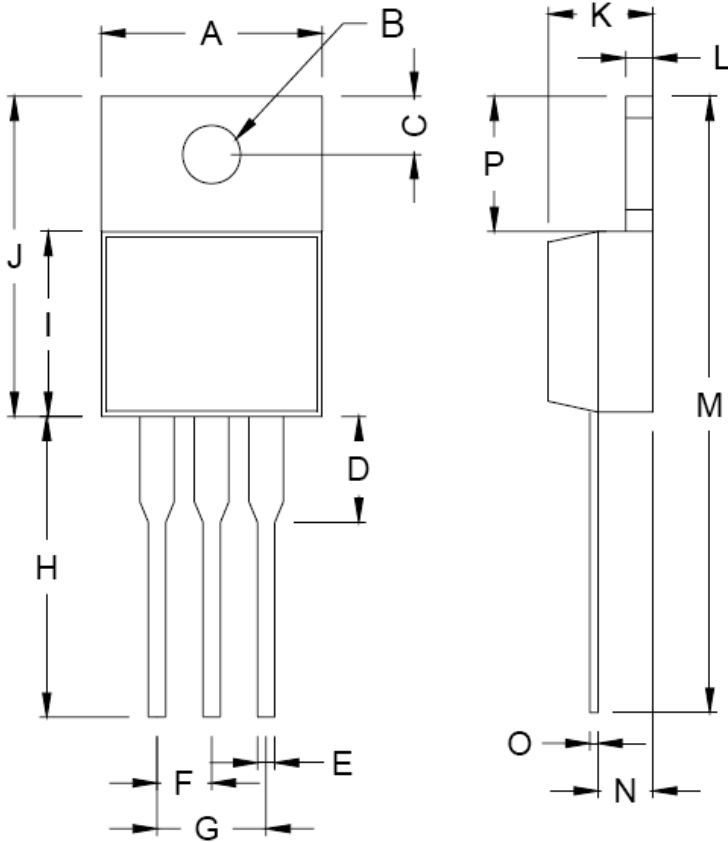


ITO-220 Mechanical Drawing



ITO-220 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.04	10.07	0.395	0.396
B	6.20 (typ.)		0.244 (typ.)	
C	2.20 (typ.)		0.087 (typ.)	
D	□1.40 (typ.)		□0.055 (typ.)	
E	15.0	15.20	0.591	0.598
F	0.52	0.54	0.020	0.021
G	2.35	2.73	0.093	0.107
H	13.50	13.55	0.531	0.533
I	1.11	1.49	0.044	0.058
J	2.60	2.80	0.102	0.110
K	4.49	4.50	0.176	0.177
L	1.15 (typ.)		0.045 (typ.)	
M	3.03	3.05	0.119	0.120
N	2.60	2.80	0.102	0.110
O	6.55	6.65	0.258	0.262

TO-220 Mechanical Drawing



TO-220 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.000	10.500	0.394	0.413
B	3.740	3.910	0.147	0.154
C	2.440	2.940	0.096	0.116
D	-	6.350	-	0.250
E	0.381	1.106	0.015	0.040
F	2.345	2.715	0.092	0.058
G	4.690	5.430	0.092	0.107
H	12.700	14.732	0.500	0.581
J	14.224	16.510	0.560	0.650
K	3.556	4.826	0.140	0.190
L	0.508	1.397	0.020	0.055
M	27.700	29.620	1.060	1.230
N	2.032	2.921	0.080	0.115
O	0.255	0.610	0.010	0.024
P	5.842	6.858	0.230	0.270

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.